

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Irwin Aberin et al.	Examiner:	Michael Jung
Serial No.:	10/588,927	Group Art Unit:	4148
Filed:	August 9, 2006	Docket No.:	I431.168.101/FIN581PCT/US
Title:	SEMICONDUCTOR PACKAGE WITH PERFORATED SUBSTRATE		

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**AMENDMENT AND RESPONSE**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This Amendment and Response is in reply to the Final Office Action mailed September 28, 2009. Please amend the above-identified patent application as follows: